

Highly Flexible and Self-Healable Electronic Skin

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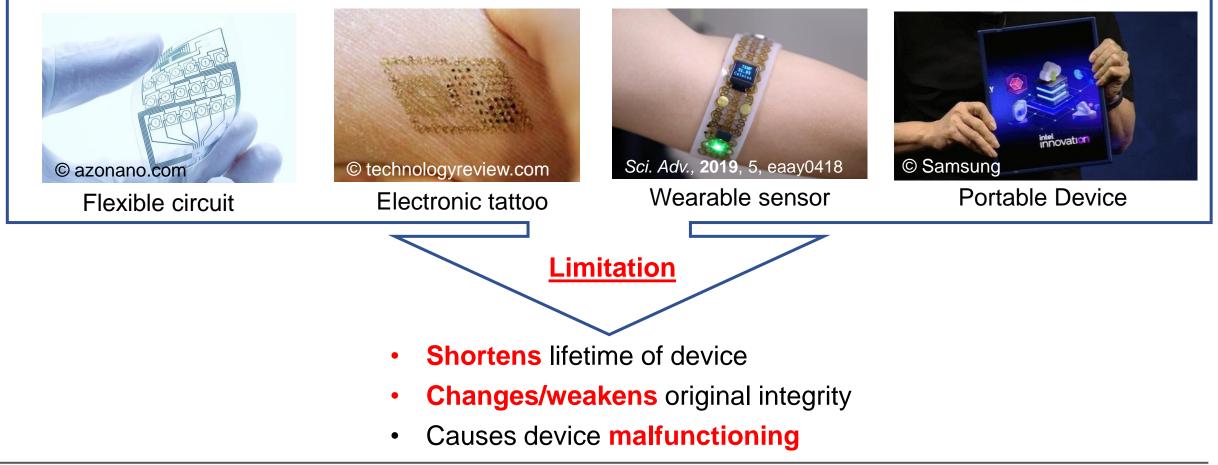


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The Needs for Next Generation of Flexible Electronics

Electronics degrade over time due to fatigue, environmental conditions, or damages incurred during operation leading to eventual failure of the material.



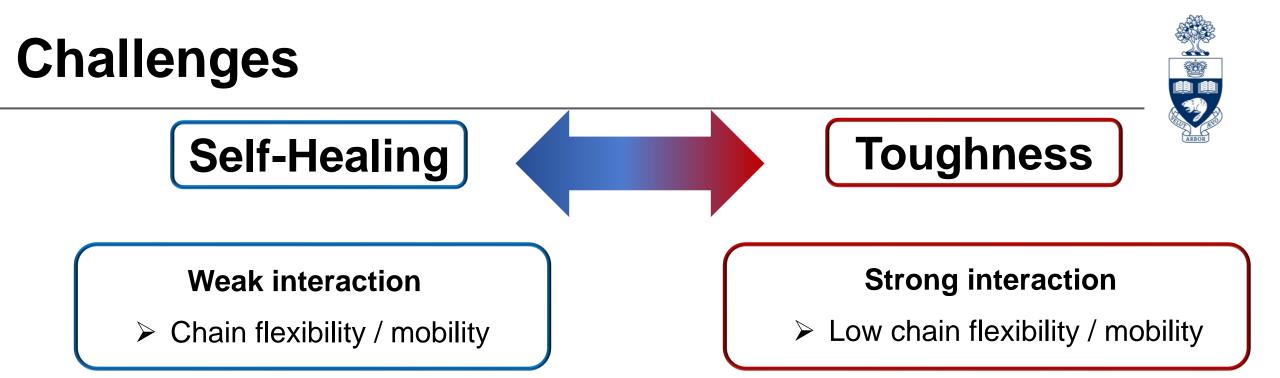
Functionalities of Flexible Electronics Flexibility • **Mechanical Properties** Toughness **Functional Substrate Materials** Intrinsic Self-healing **Self-Healing Extrinsic Self-healing Platform** TENG • **Energy Harvesting** Solar cell for **Self-Powered Devices** Flexible Battery **Energy Storage** Supercapacitor **Electronics** Pressure sensor Strain sensor **Tactile Sensor** Temperature sensor Sensors Electrophysiological ullet**Health Monitoring Chemical sensor** •

Motivation

- Facile methodology for flexible electronics with high-performing device performance
- Substrate material for long-term utilization of devices
 - Material exhibiting the self-healing properties with high toughness

Objectives

- Fabricate supercapacitor through facile methodology
- Design and synthesize self-healing polymer for flexible electronics
- Achieve high toughness material that exhibits self-healing behavior

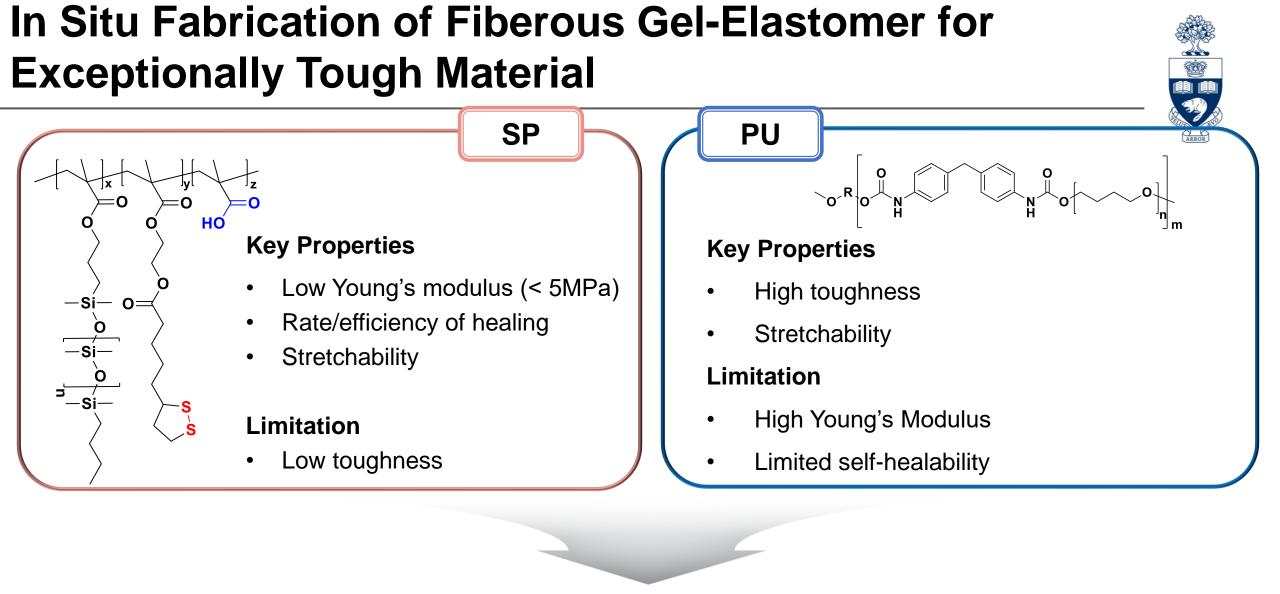


Reported strategies to enhance toughness for smart skin:

1) Addition of filler

2) Molecular modification of polydimethylsiloxane (PDMS)

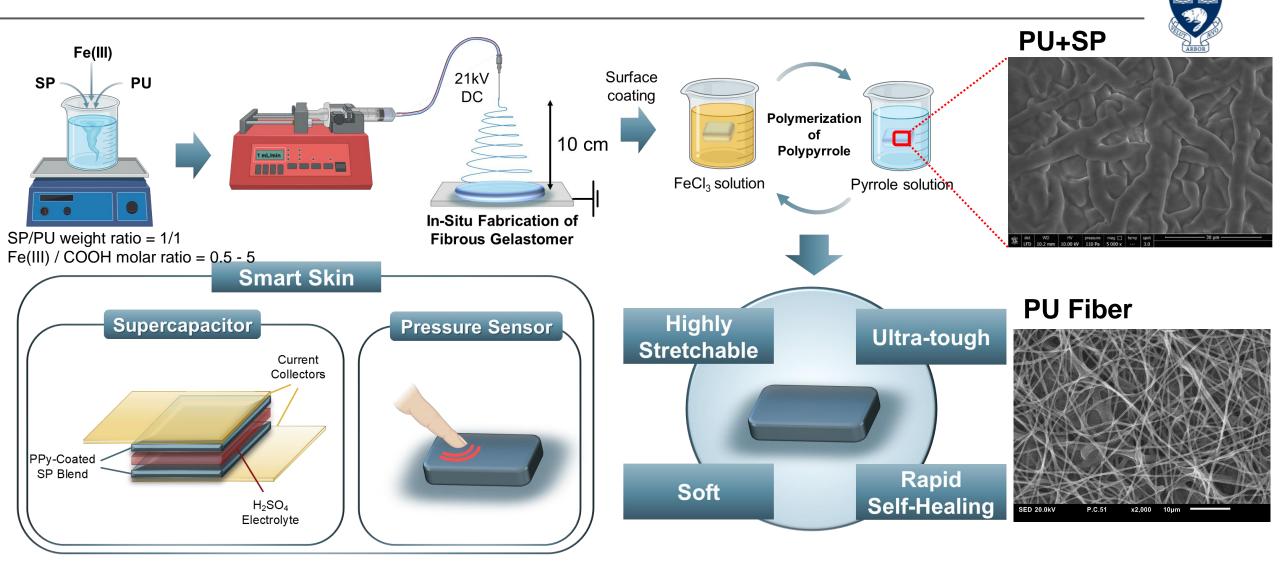
3) Molecular modification of polyurethane (PU)



Blend!

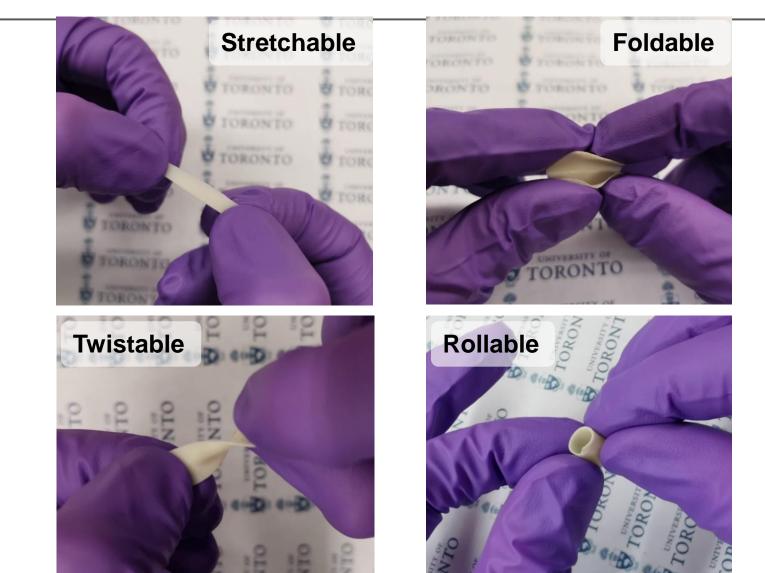
SP = self-healing polymer PU = polyurethane

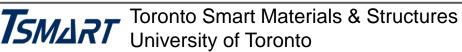
Fabrication of SPB Gel-Elastomer



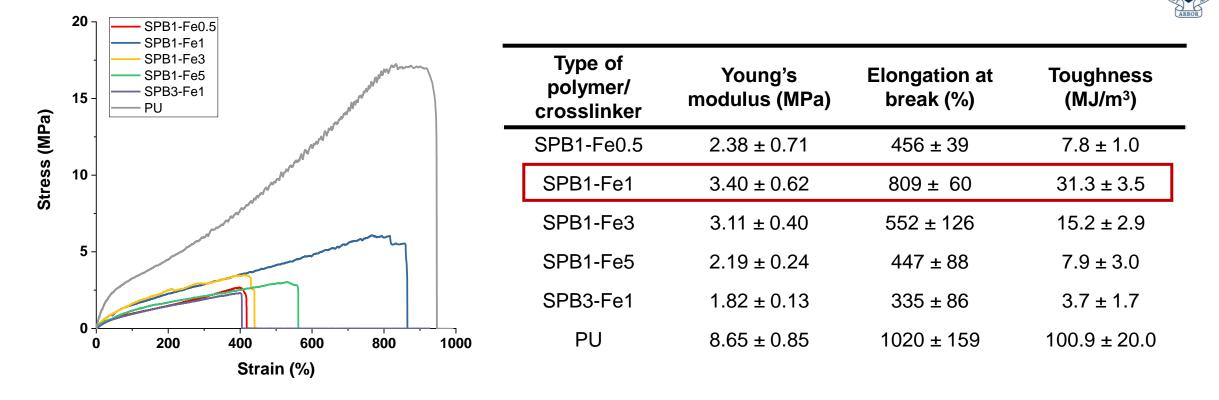
Fabrication of SPB Gelastomer







Mechanical Properties of SPBs

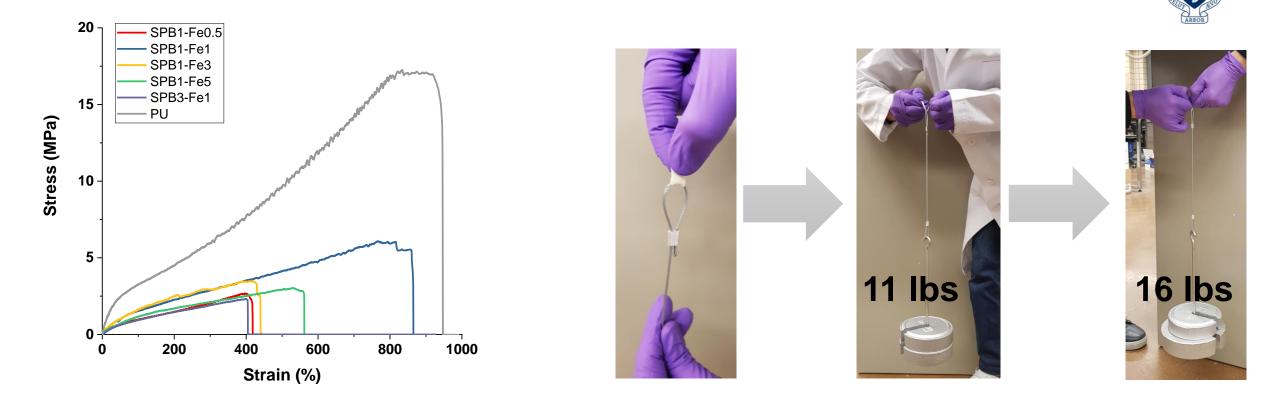


- Young's modulus was significantly reduced.
- Relatively high toughness was achieved.

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• High fracture strain due to transient boding that dissipates the stretching energy through association-dissociation

Mechanical Properties of SPB



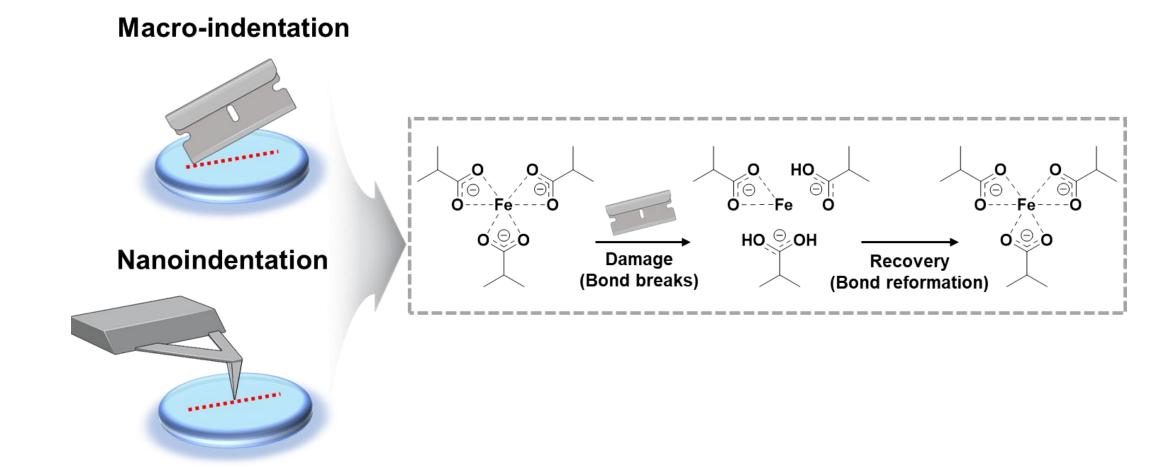
- Young's modulus was significantly reduced.
- Toughness was enhanced.

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High fracture strain due to transient boding that dissipates the stretching energy through association-dissociation

Self-Healing Capability of SPB

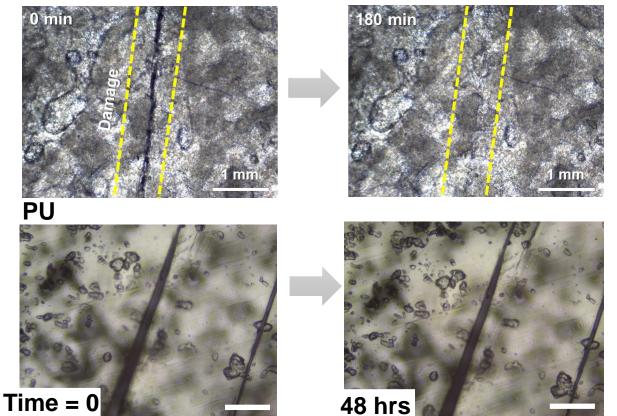




Self-Healing Test at Macroscale



SPB1-Fe1

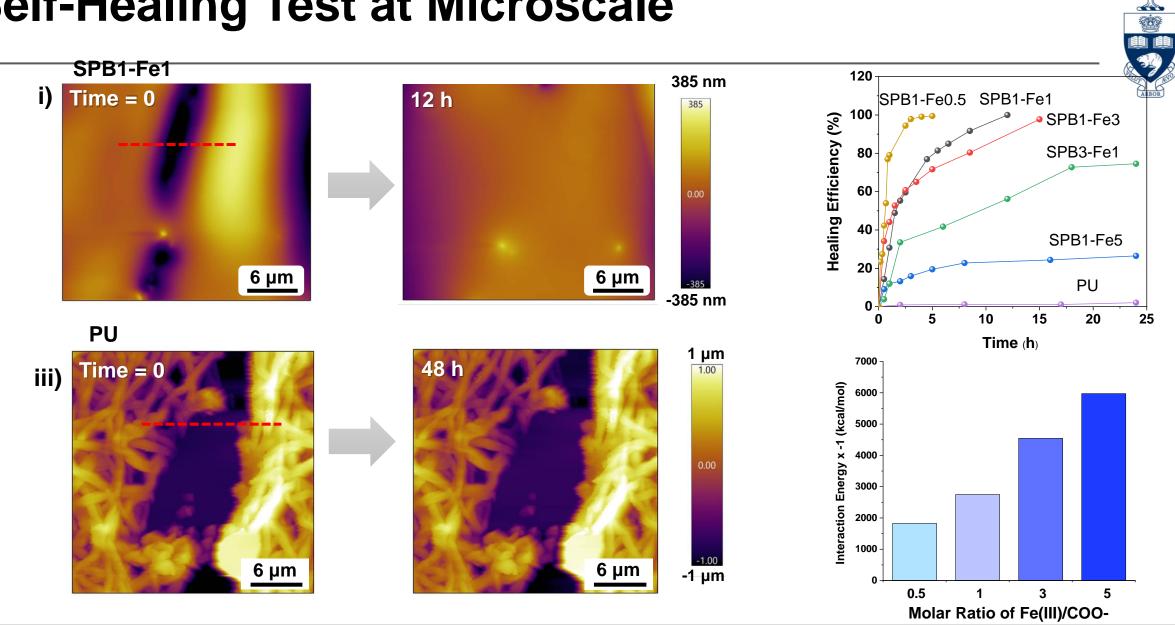


- Macro-indentation experiment is representative of damages from everyday life.
- Optical microscopic images show that the self-healing polymer blend heals at room temperature without any energy input.

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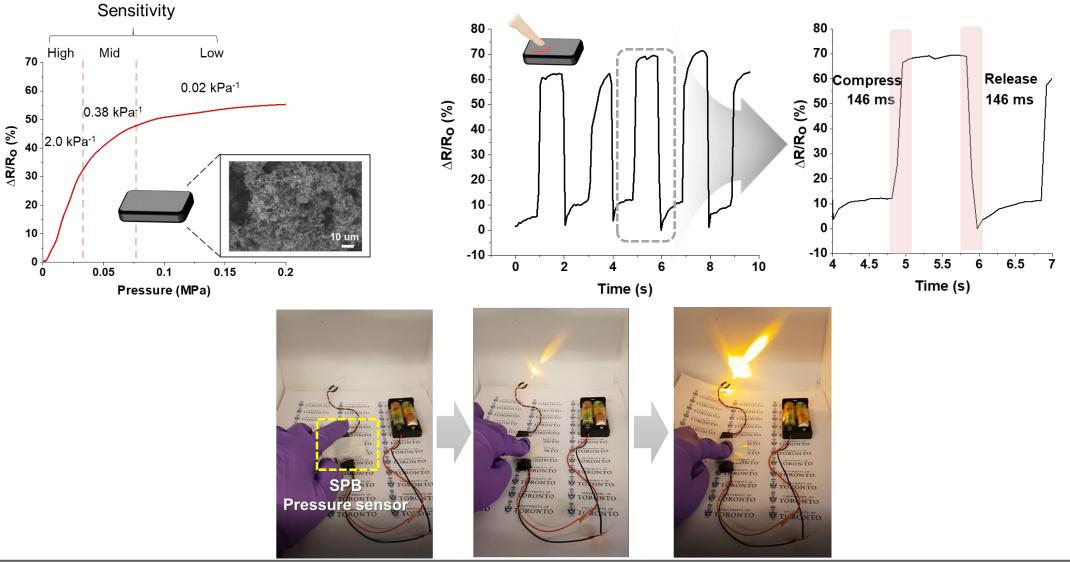
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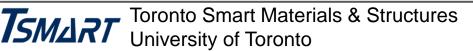
Self-Healing Test at Microscale



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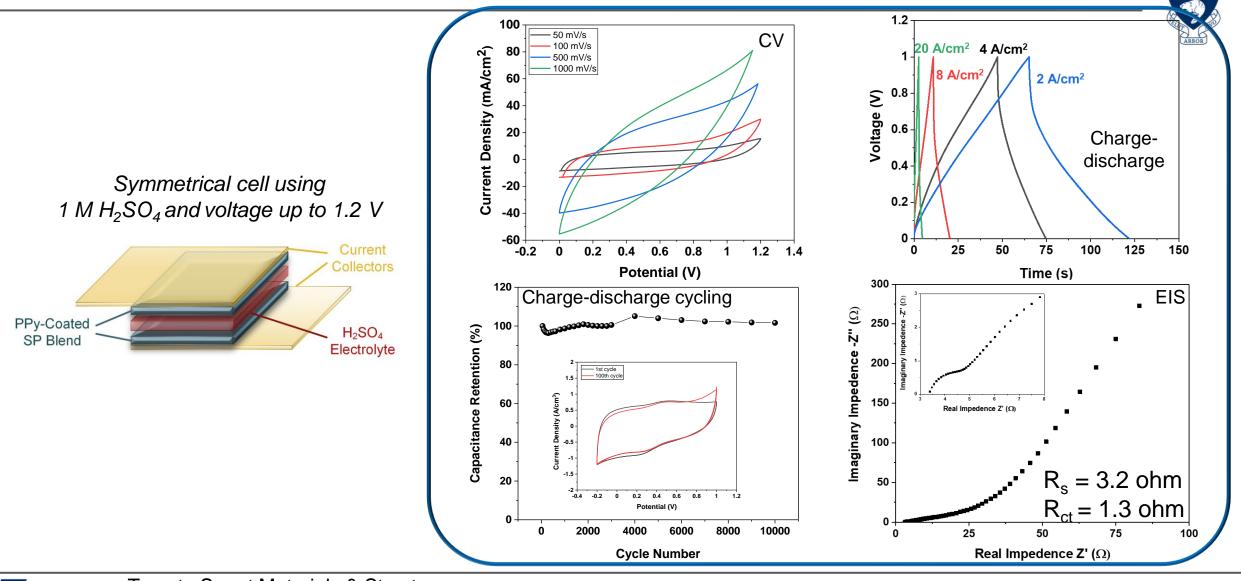
Tactile Sensing Capability of SPB







SPB as an Energy Storage Device



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Conclusion



- Gel and elastomer polymer blend has not been studied for highly tough and self-healing material.
- Homogenous and freestanding material was obtained from electrospinning in-situ.
- Achieved a high toughness below 5 MPa of Young's Modulus.
- Efficient healing at room temperature without any external aid.
- Demonstrated the capability for smart skin as an energy storage device and tactile sensors.



Thank You for Your Attention!